

#### US00D420927S

### United States Patent

### Yano

IC TEST-HEAD STAND Inventor: Takayuki Yano, Tokyo, Japan Assignee: Advantest Corporation, Tokyo, Japan 14 Years Term: Appl. No.: 29/098,530 Dec. 30, 1998 Filed: [52] [58] D34/17; 37/265, 434, 285; 280/47.24; 294/54.5, 55 [56] **References Cited** 

#### U.S. PATENT DOCUMENTS

D. 286,698	11/1986	Spicer	D34/12 X
D. 383,582	9/1997	Sinclair, Jr	D34/12 X

Primary Examiner—Antoine Duval Davis Attorney, Agent, or Firm—Birch, Stewart, Kolasch & Birch, LLP

[57] **CLAIM** 

The ornamental design for an IC test-head stand, as shown and described.

### **DESCRIPTION**

FIG. 1 is a perspective view of an IC test-head stand according to a first embodiment of the present design.

FIG. 2 is a front view of the IC test-head stand shown in FIG. 1. A rear view of the IC test-head stand is omitted from the drawing since the rear view is symmetrical with the front view.

FIG. 3 is a left side view of the IC test-head stand shown in FIG. 1.

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**Date of Patent:** \*\* Feb. 22, 2000 [45]

FIG. 4 is a right side view of the IC test-head stand shown in FIG. 1.

FIG. 5 is a top plan view of the IC test-head stand shown in FIG. 1.

FIG. 6 is a bottom plan view of the IC test-head stand shown in FIG. 1.

FIG. 7 is a perspective view of an IC test-head stand according to a second embodiment of the present design.

FIG. 8 is a front view of the IC test-head stand shown in FIG. 7. A rear view of the IC test-head stand is omitted from the drawing since the rear view is symmetrical with the front view.

FIG. 9 is a left side view of the IC test-head stand shown in FIG. 7.

FIG. 10 is a right side view of the IC test-head stand shown in FIG. 7.

FIG. 11 is a top plan view of the IC test-head stand shown in FIG. 7.

FIG. 12 is a bottom plan view of the IC test-head stand shown in FIG. 7.

FIG. 13 is a perspective view of an IC test-head stand according to a third embodiment of the present design.

FIG. 14 is a front view of the IC test-head stand shown in FIG. 13. A rear view of the IC test-head stand is omitted from the drawing since the rear view is symmetrical with the front view.

FIG. 15 is a left side view of the IC test-head stand shown in FIG. 13.

FIG. 16 is a right side view of the IC test-head stand shown in FIG. 13.

FIG. 17 is a top plan view of the IC test-head stand shown

in FIG. 13. FIG. 18 is a bottom plan view of the IC test-head stand

shown in FIG. 13; and, FIG. 19 is a front view of the IC test-head stand shown in

FIG. 1, for illustrating the use of the IC test-head stand. The broken line showing is for illustrative purposes only and forms no part of the claimed design.

### 1 Claim, 10 Drawing Sheets

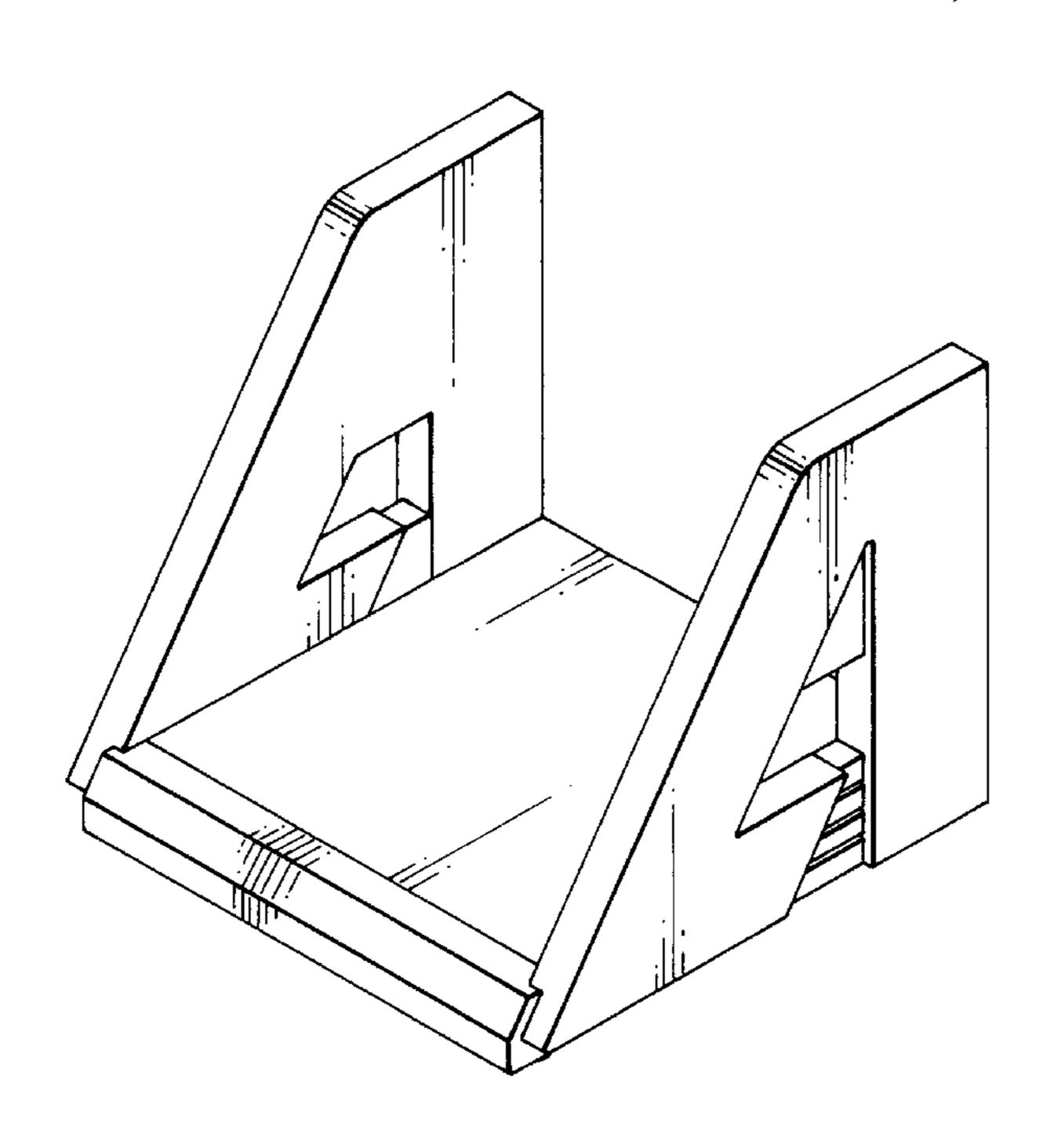


FIG.

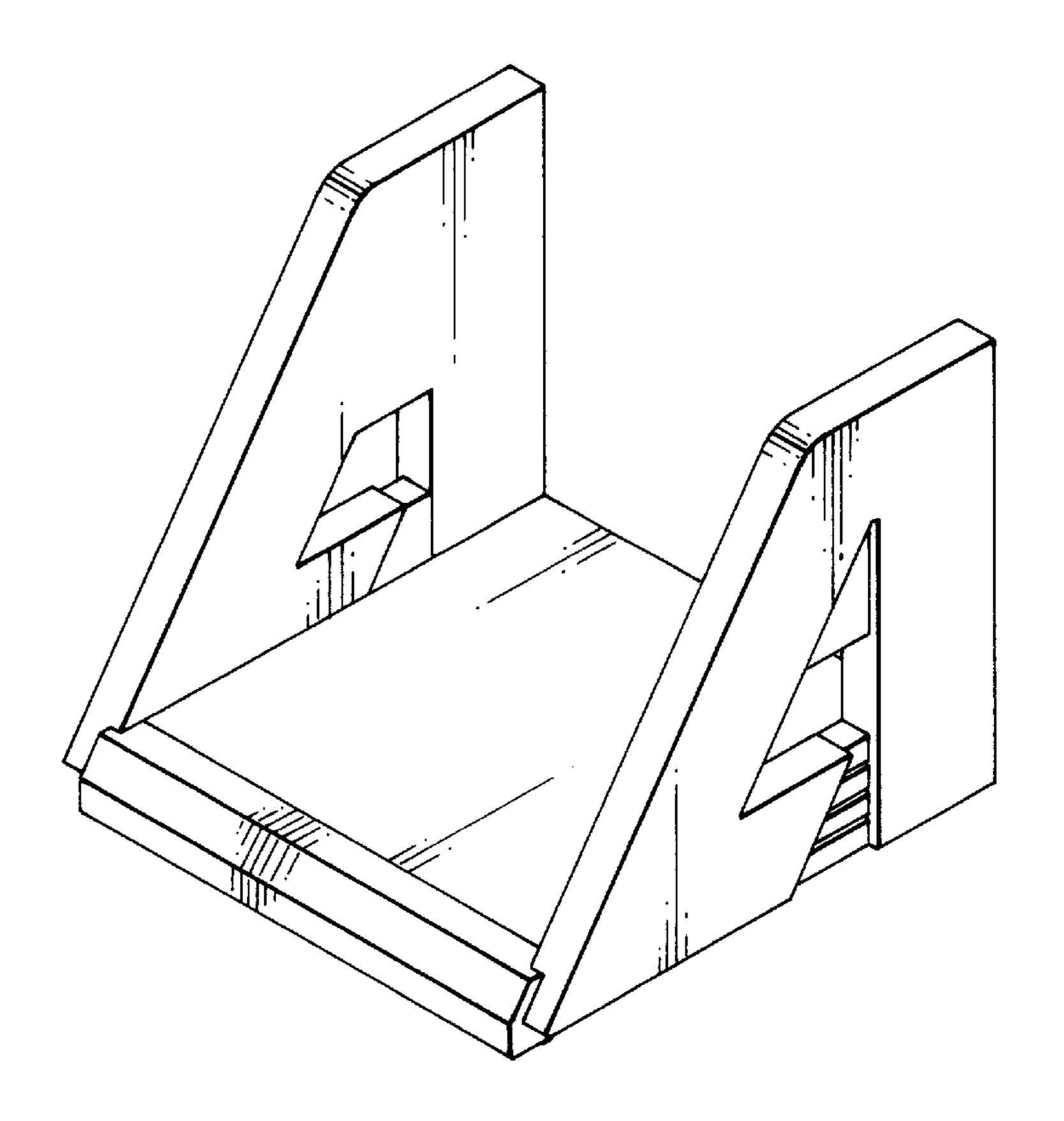


FIG. 2

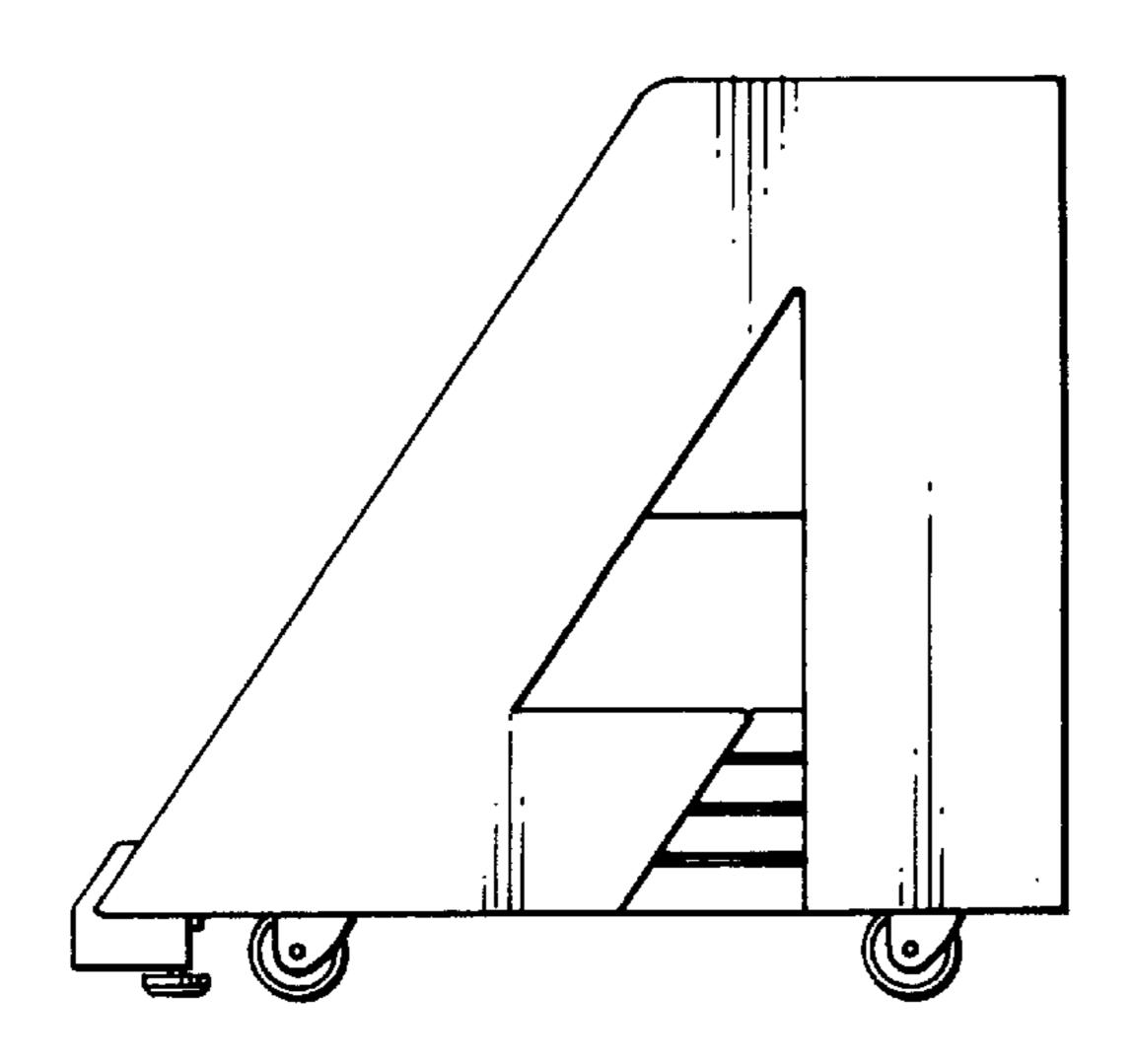


FIG. 3

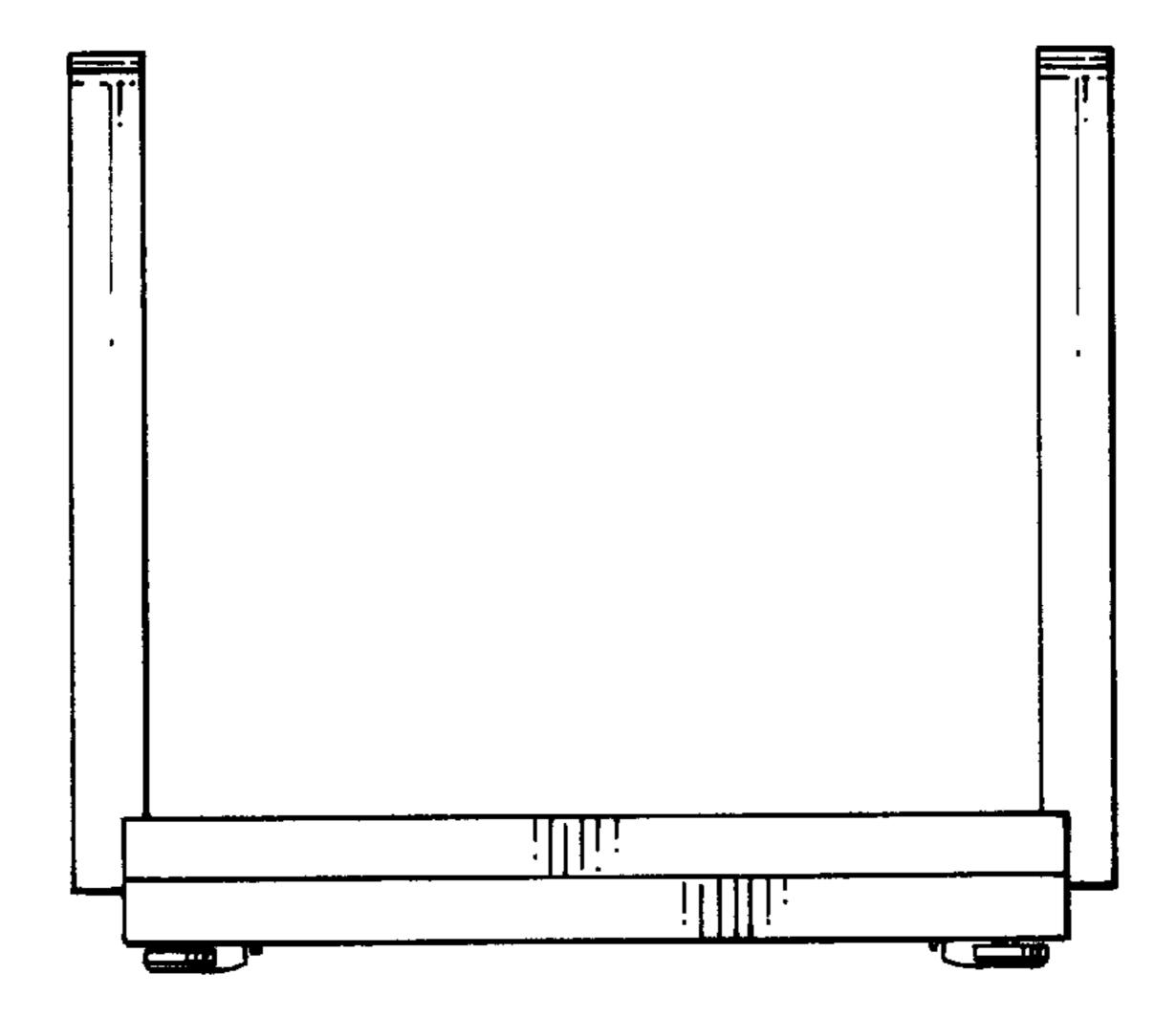


FIG. 4

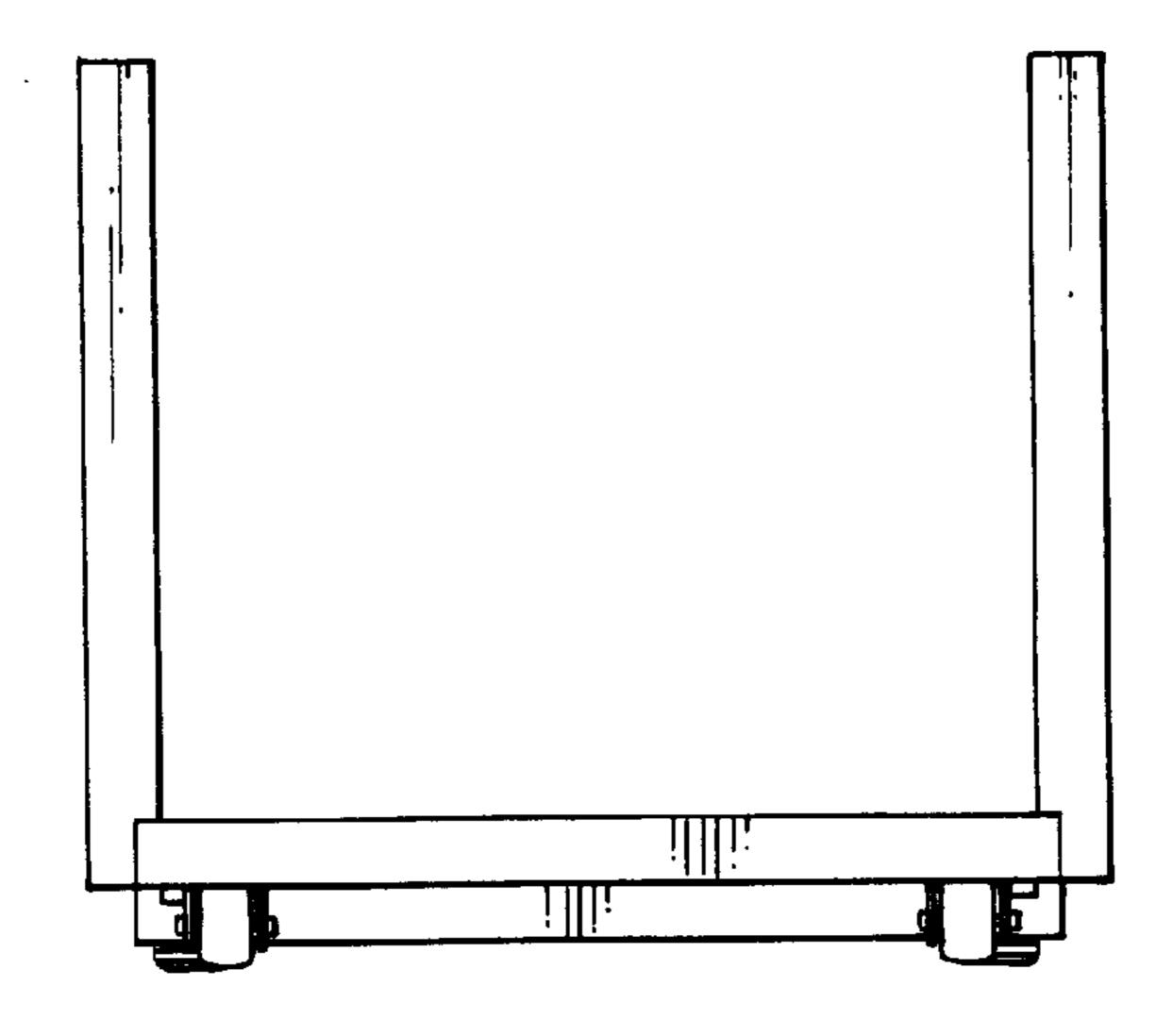


FIG. 5

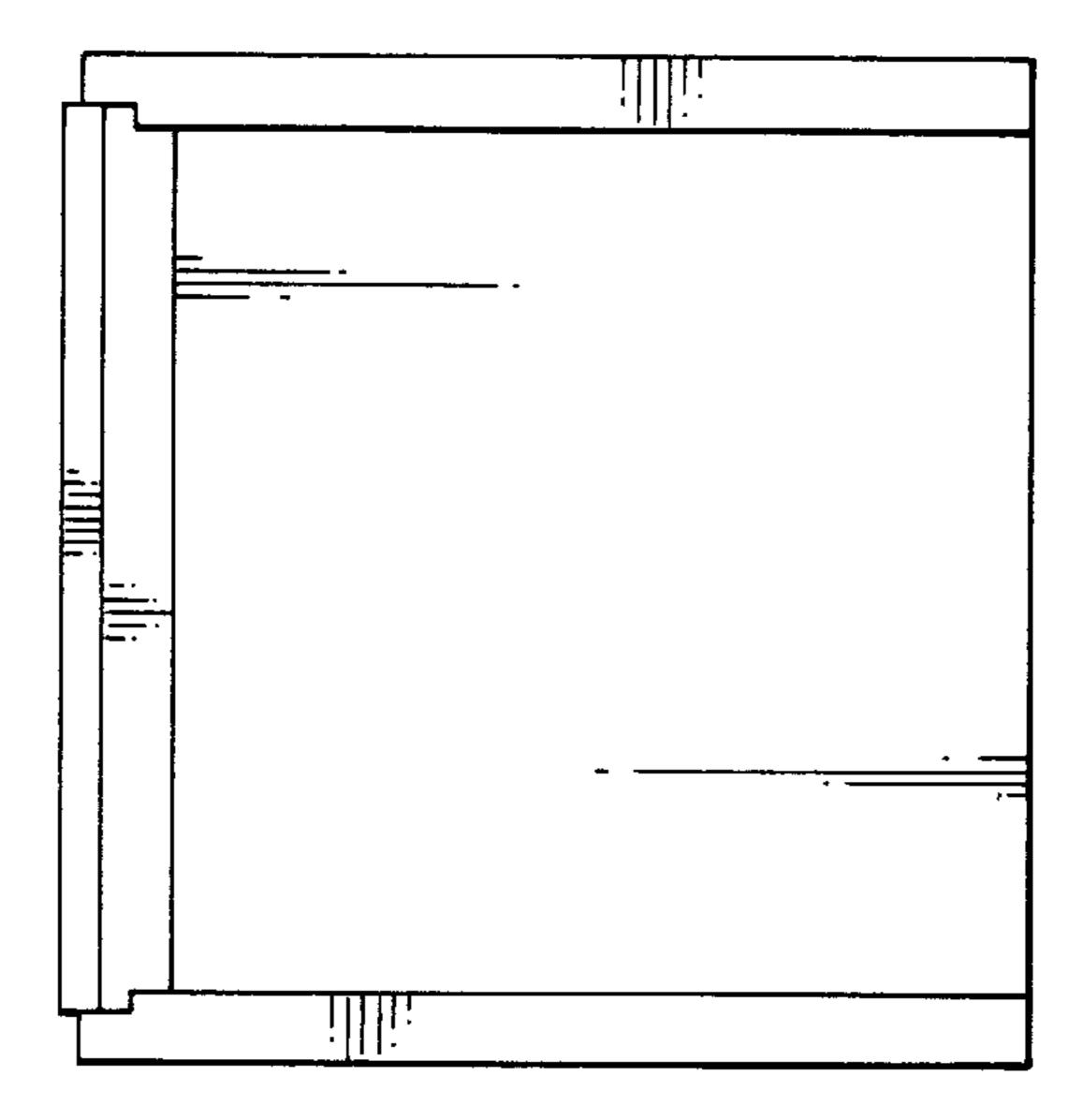


FIG. 6

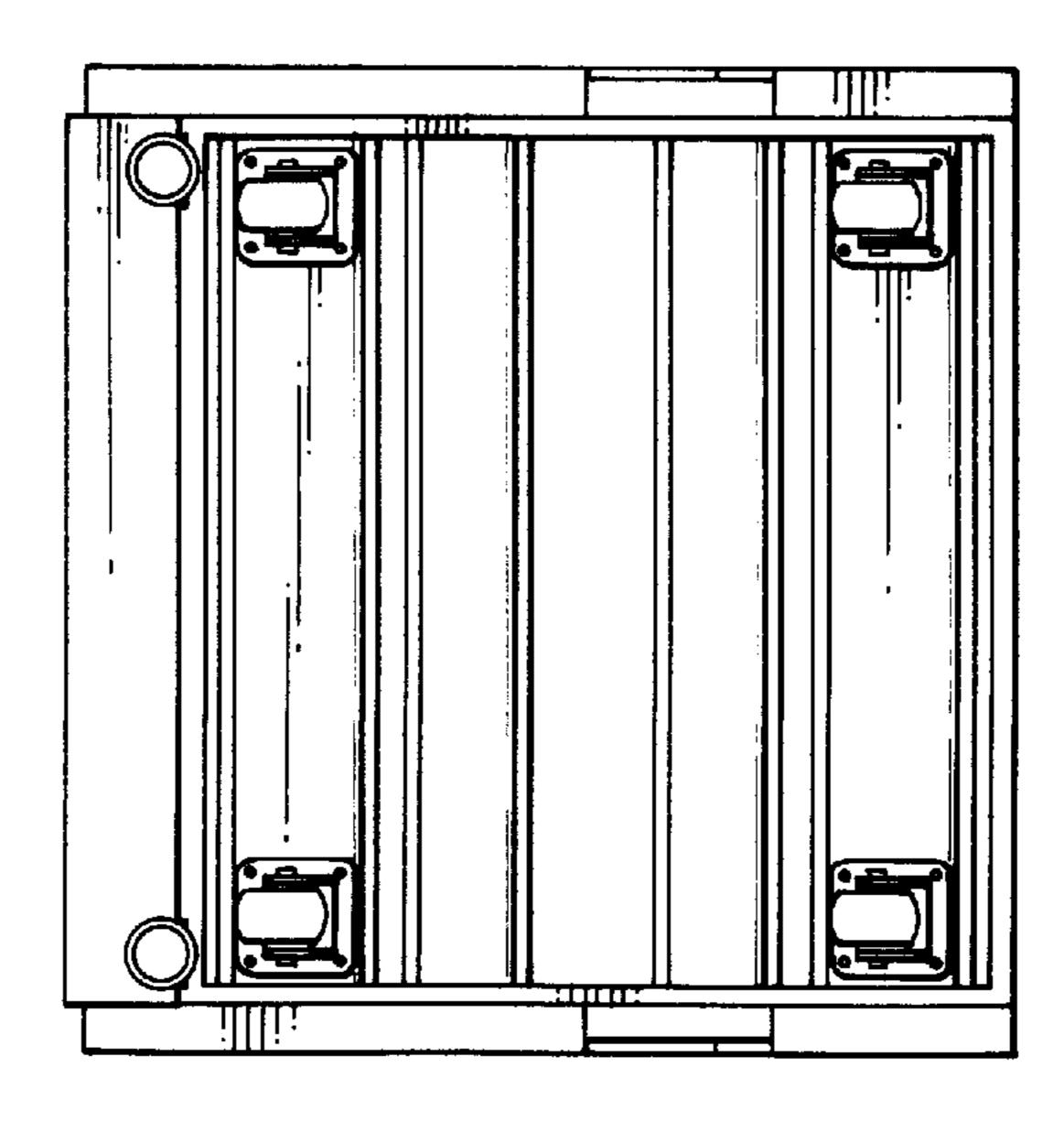


FIG. 7

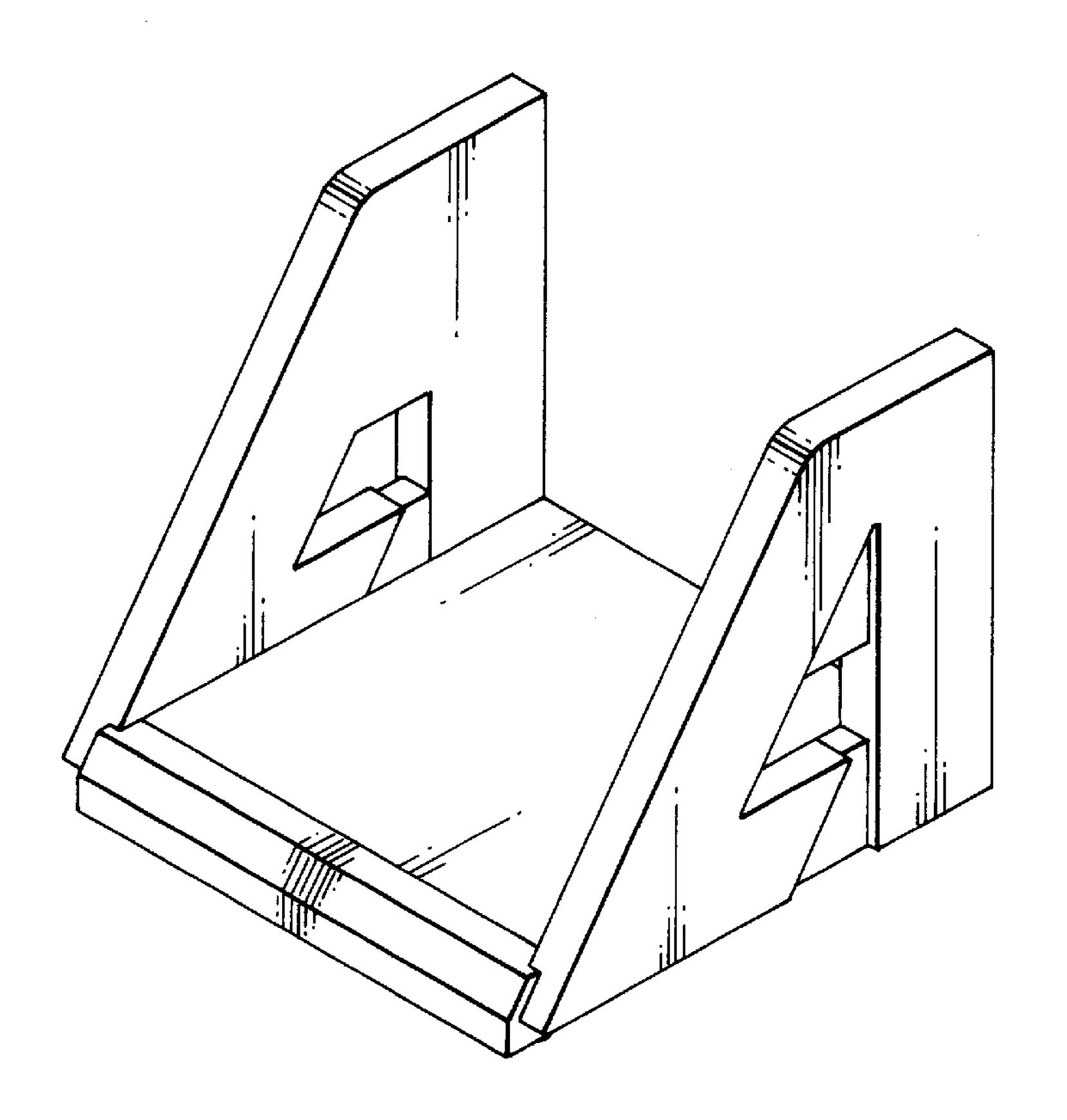


FIG. 8

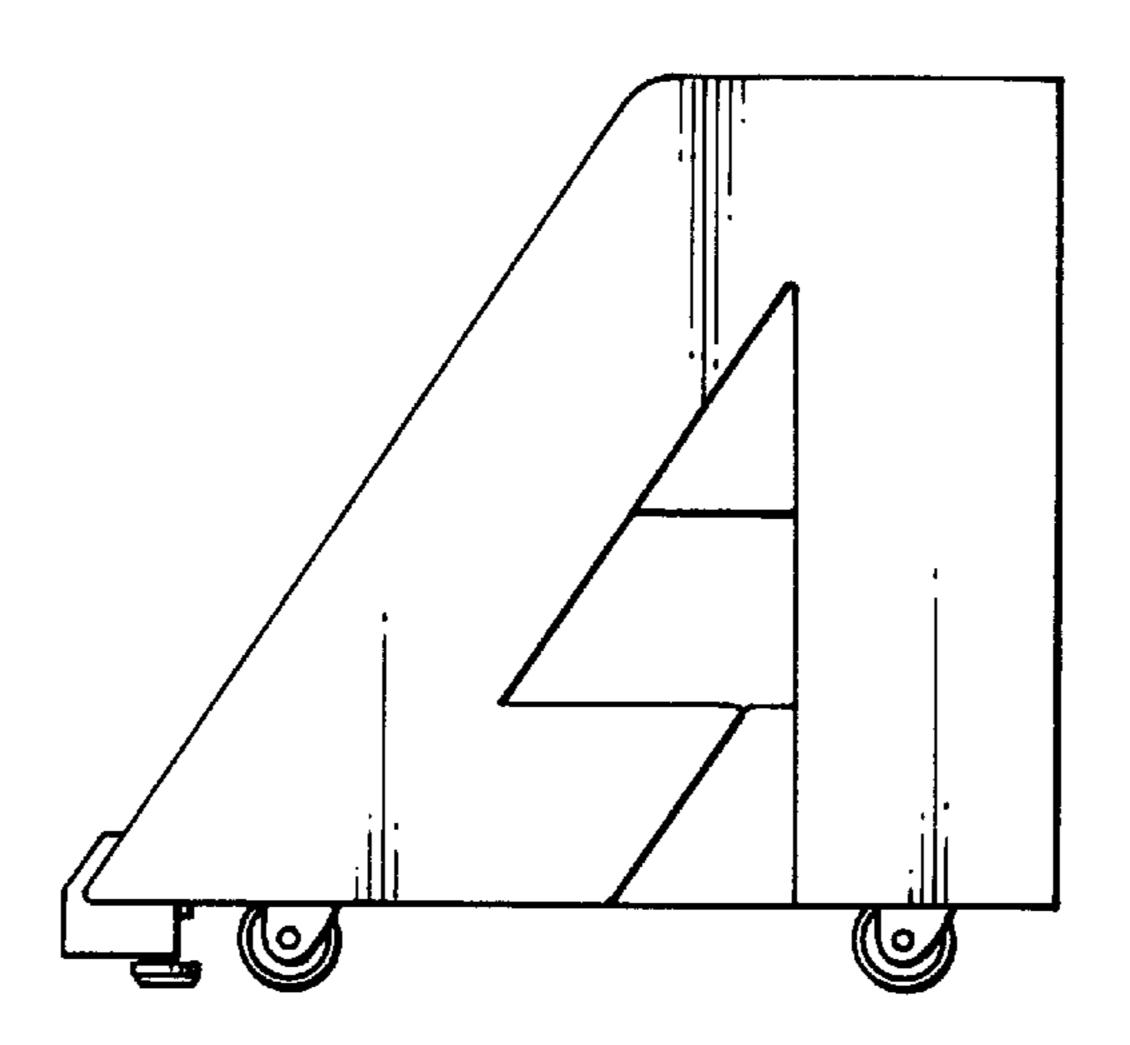


FIG. 9

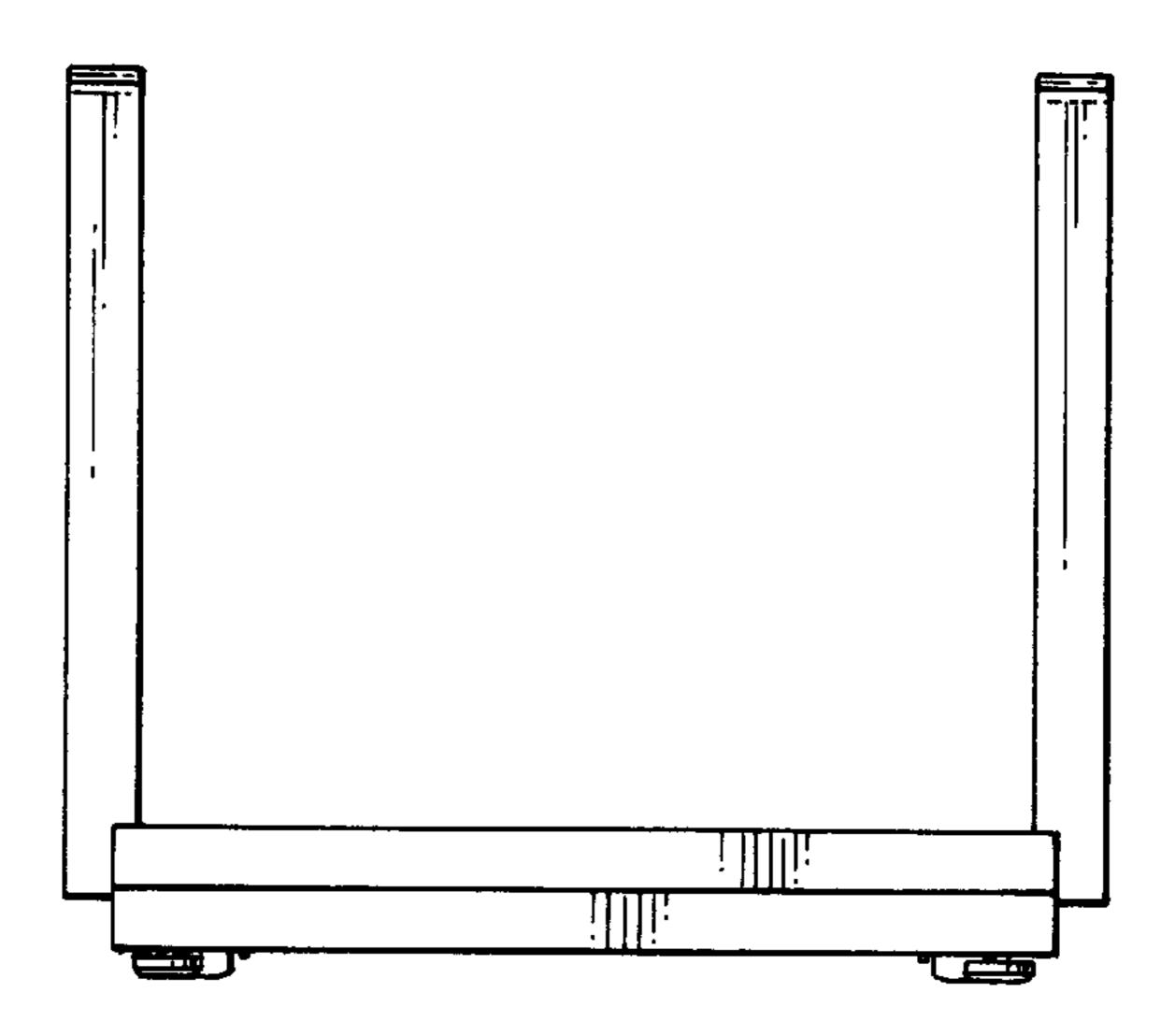


FIG. 10

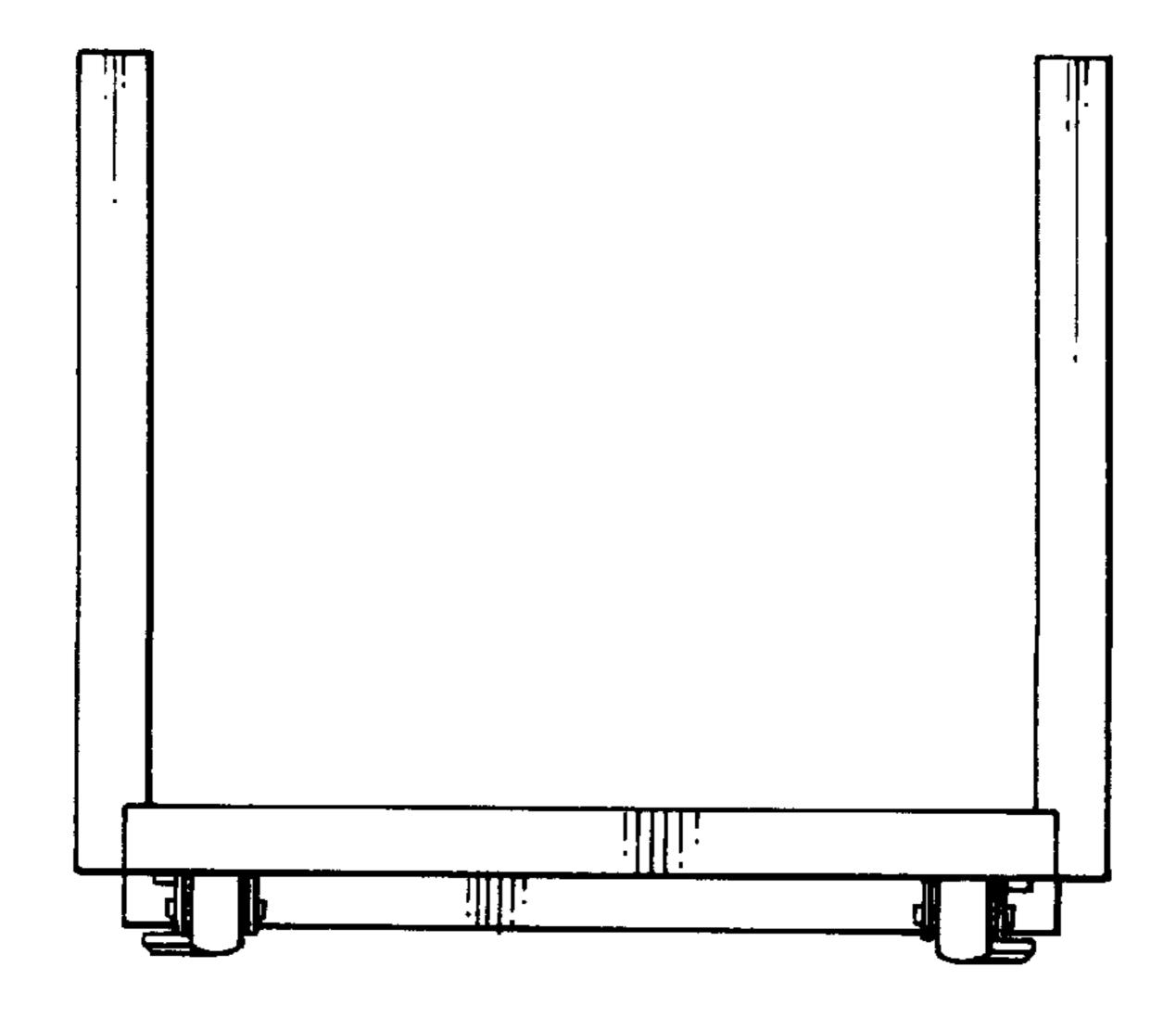


FIG. 1

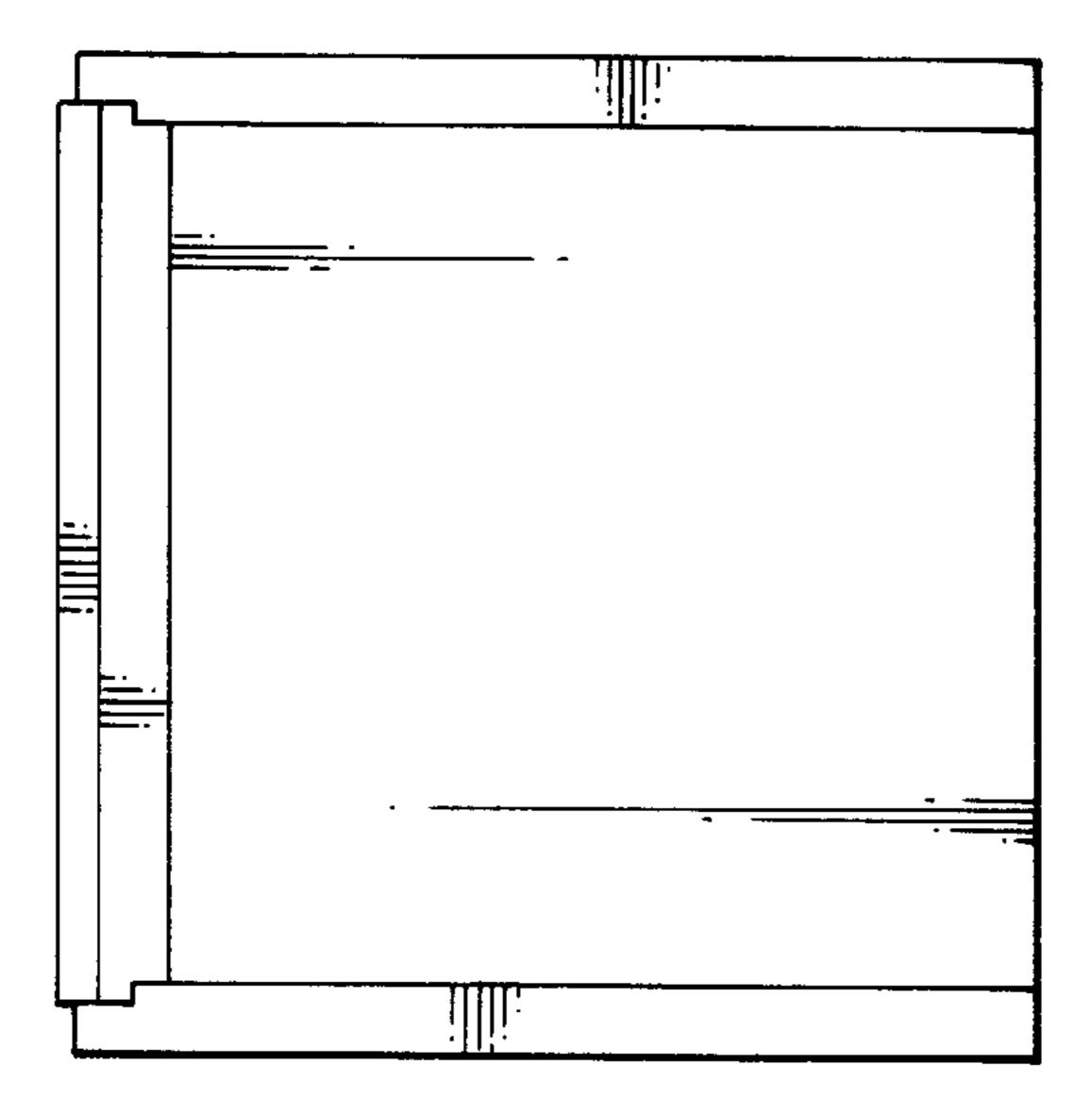


FIG. 12

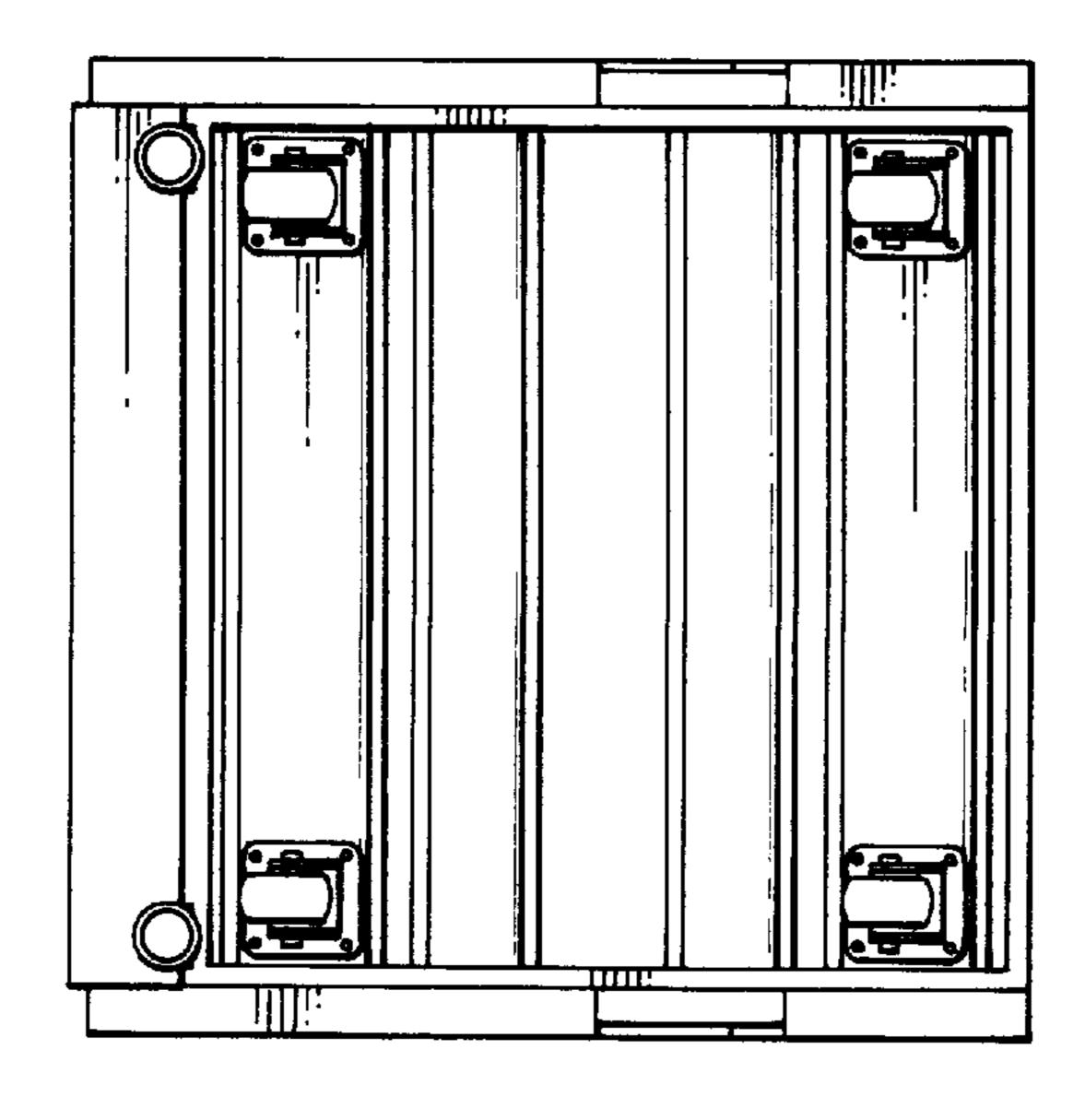


FIG. 13

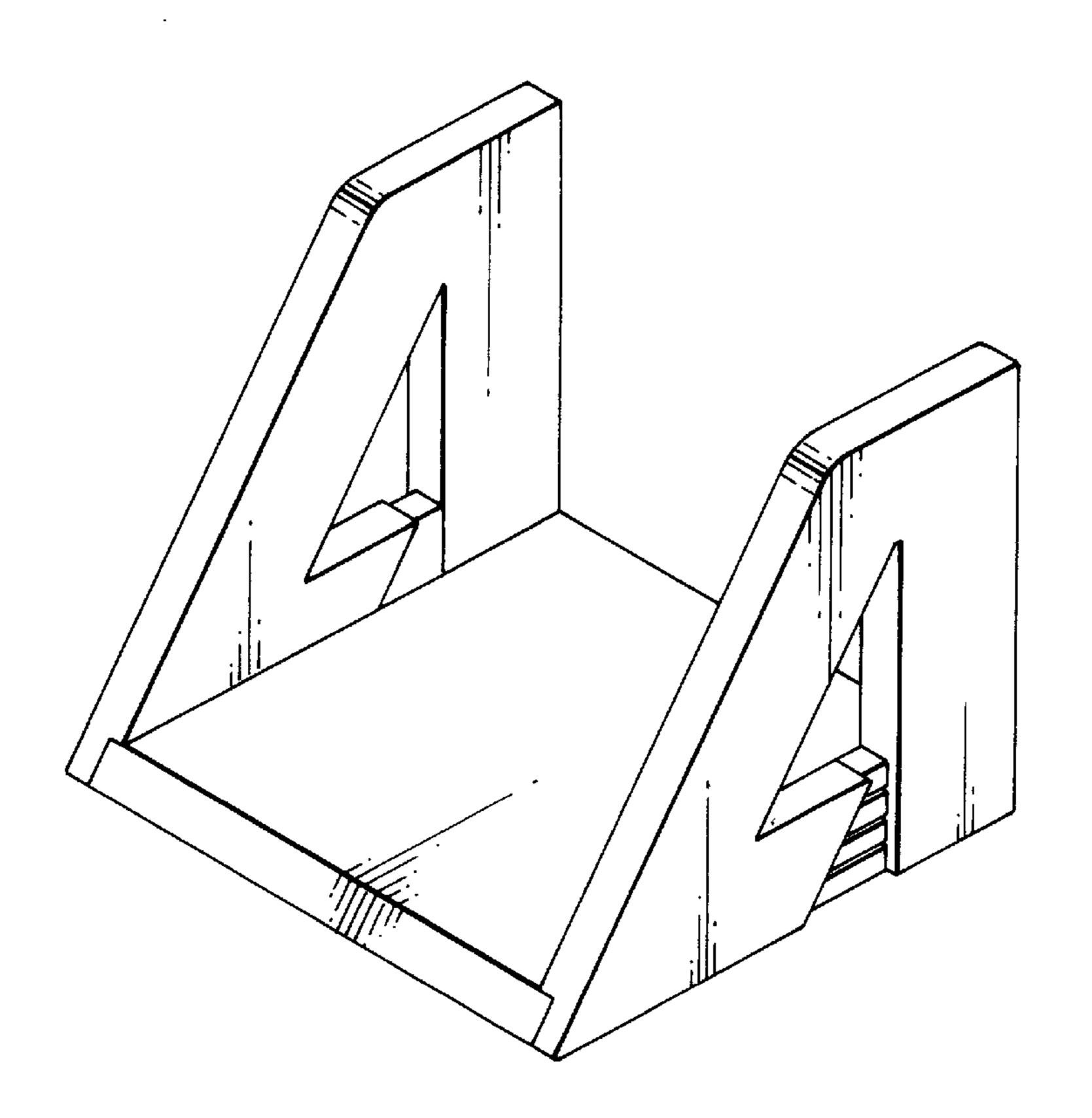
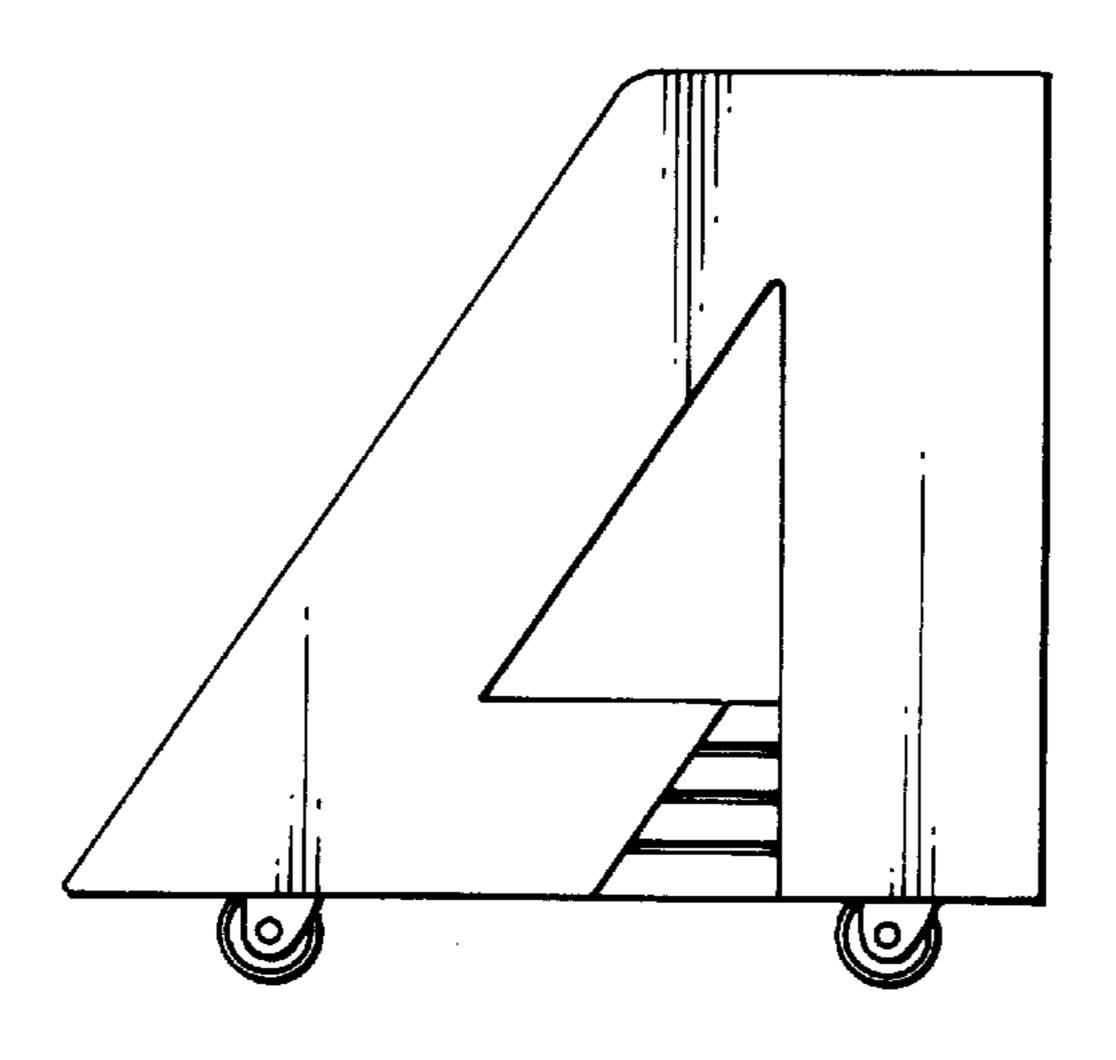
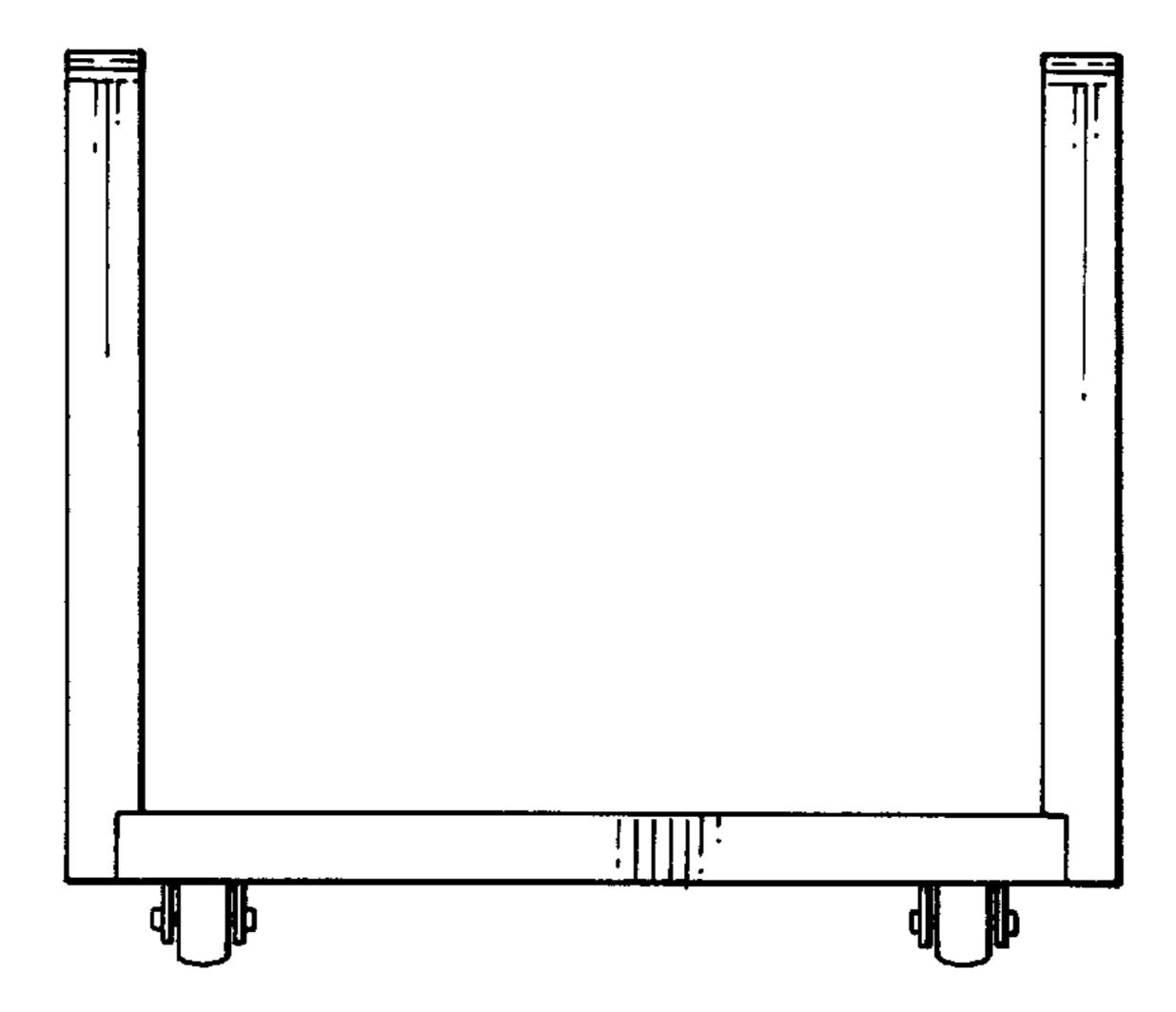


FIG. 14



F1G. 15



F1G. 16

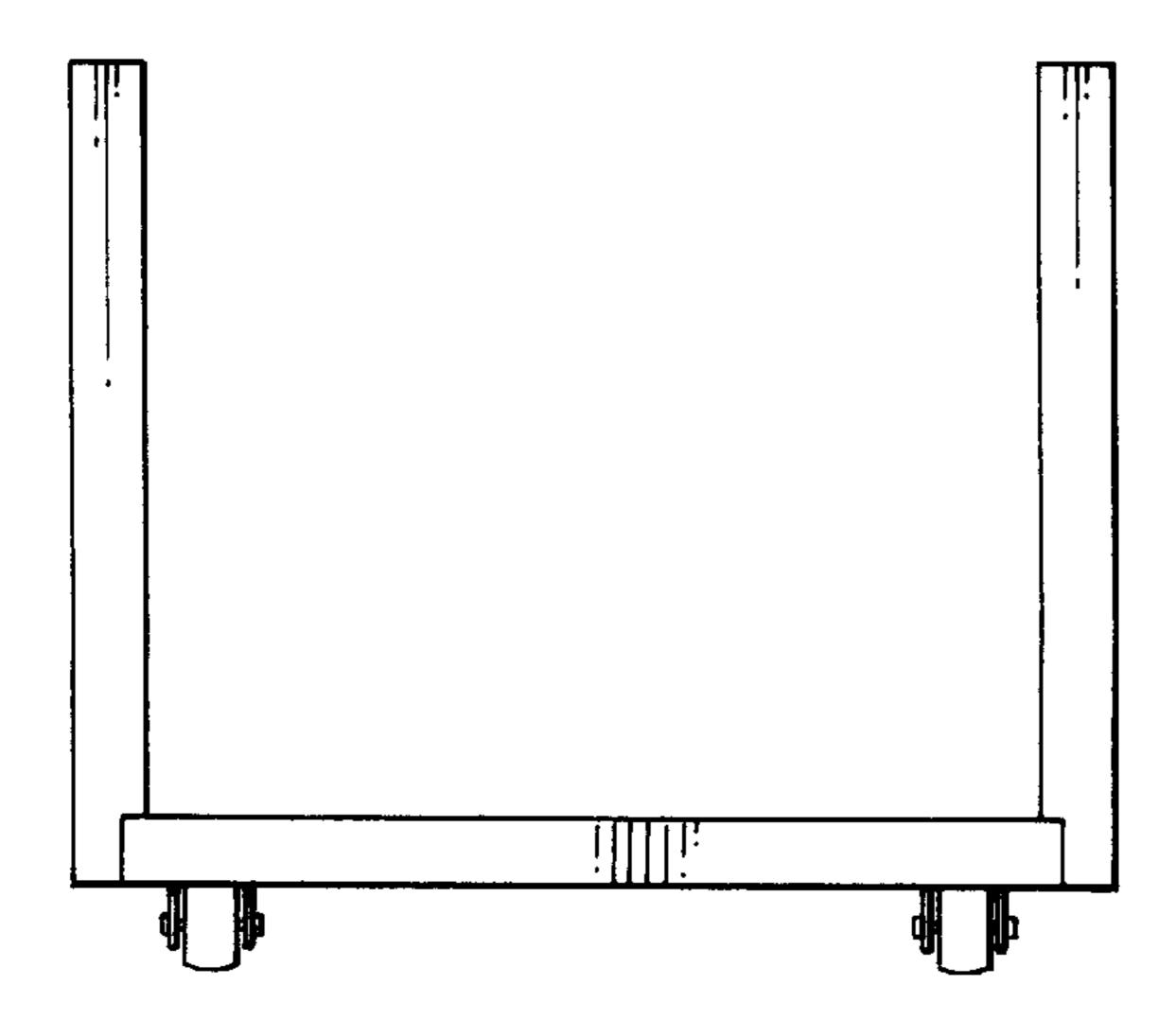
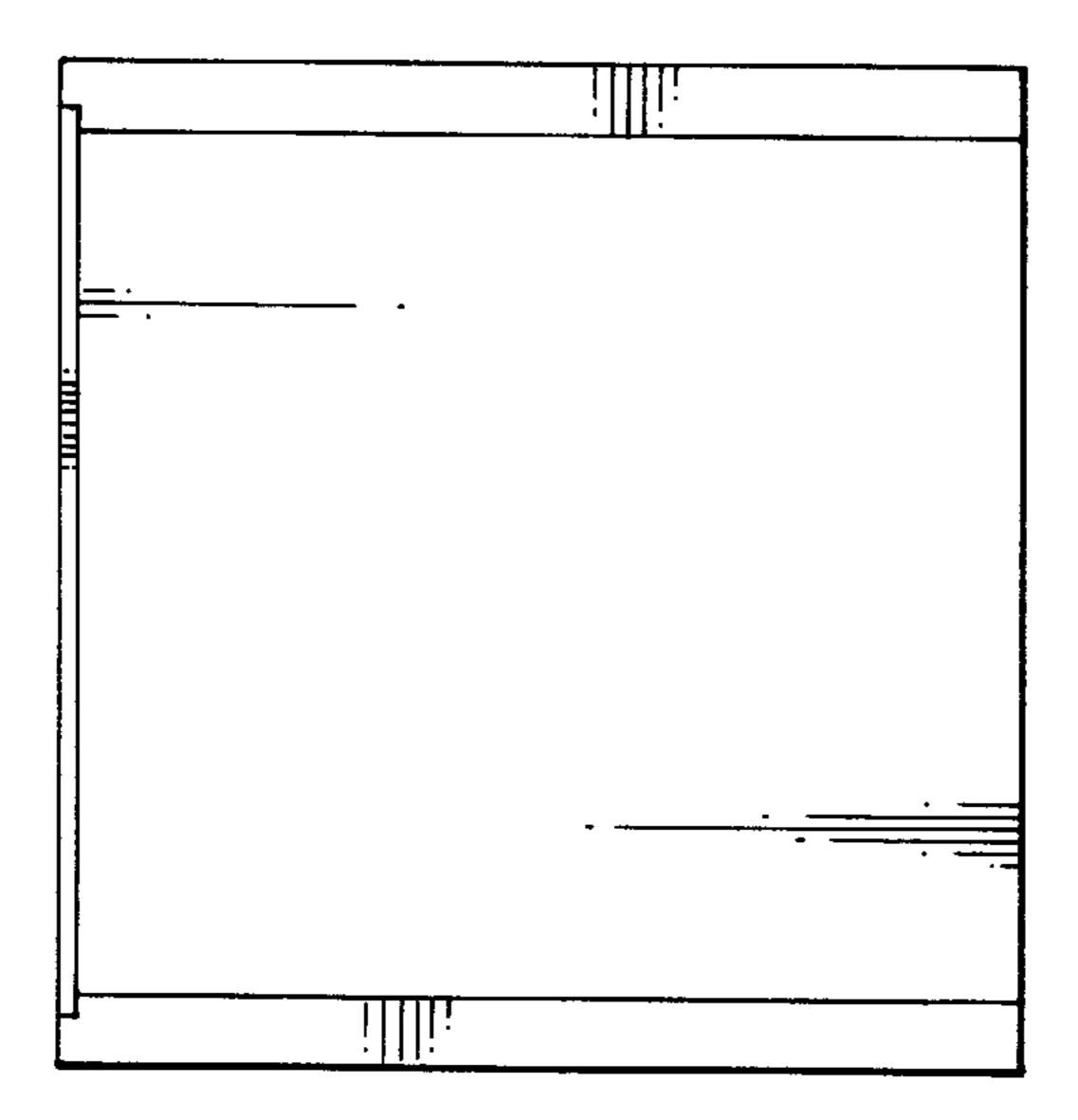
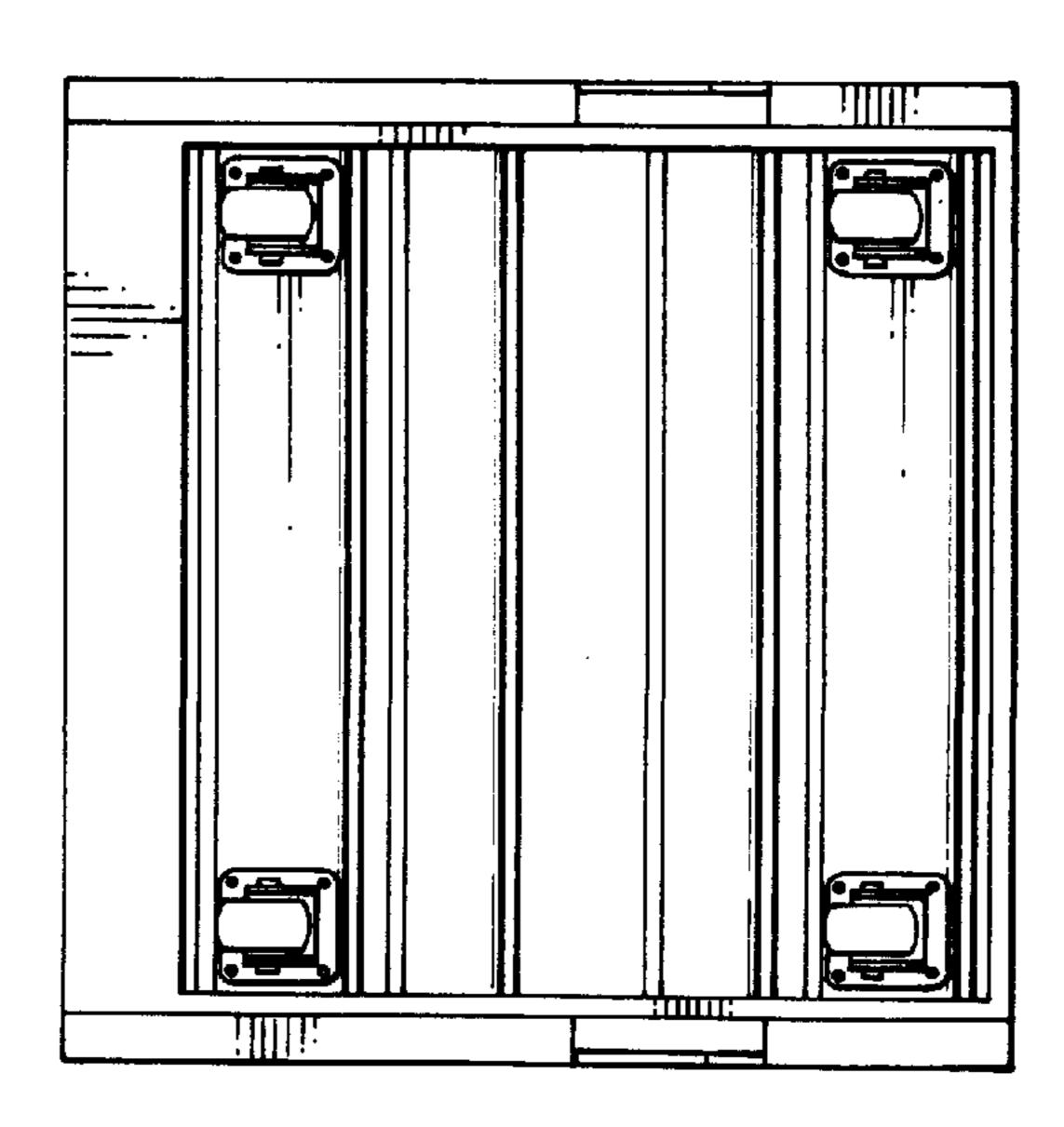


FIG. 17

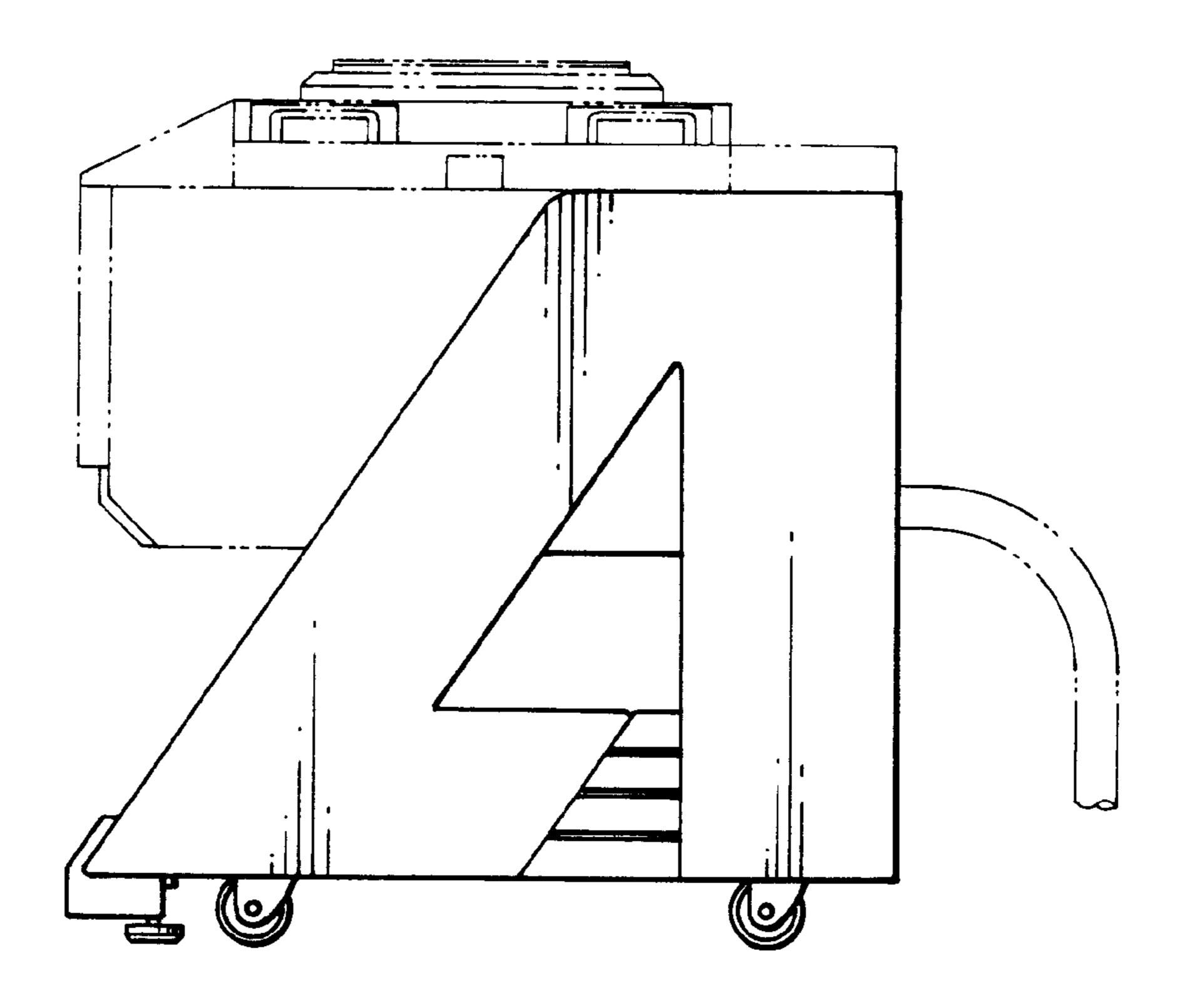


F1G. 18



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# F1G.19



### UNITED STATES PATENT AND TRADEMARK OFFICE CERTIFICATE OF CORRECTION

PATENT NO.

:Des 420,927

Page 1 of 1

DATED

:February 22, 2000 INVENTOR(S) : Takayuki Yano

> It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

### Title Page:

Insert the following Priority Data:

"JAPAN 10-19566 July 7, 1998; JAPAN 10-19567 JULY 7, 1998, and JAPAN 10-19568 JULY 7, 1998".

Signed and Sealed this

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Attesting Officer

Acting Director of the United States Patent and Trademark Office

## UNITED STATES PATENT AND TRADEMARK OFFICE CERTIFICATE OF CORRECTION

PATENT NO. : Des. 420,927

DATED : February 22, 2000 INVENTOR(S) : Takayuki Yano

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

### Title page,

Insert Item:

-- [30] Foreign Application Priority Data

JAPAN 10-19566 July 7, 1998; JAPAN 10-19567 July 7, 1998; and JAPAN 10-19568 July 7, 1998 ---.

Signed and Sealed this

Seventh Day of December, 2004

JON W. DUDAS

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